



1/2.7-Inch 2.3 Mp Digital Image Sensor

AR0231 Datasheet, Rev. 2

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Features

- · Key technologies:
 - Automotive grade Backside Illuminated Pixel
 - LED Flicker Mitigation mode
 - Sensor Fault Detection for ASIL-B Compliance
 - Up to 4-exposure HDR at 1928x1208 and 30 fps or 3-exposure HDR at 1928x1208 and 40 fps.
- Latest 3.0 µm Back Side Illuminated (BSI) pixel with ON Semiconductor DR-Pix™ technology
- Data interfaces: up to 4-lane MIPI CSI-2, Parallel, or up t0 4-lane high speed pixel interface (HiSPi) serial interface (SLVS and HiVCM)
- Advanced HDR with flexible exposure ratio control
- LED Flicker Mitigation (LFM) mode
- Selectable automatic or user controlled black level control
- Frame to frame switching among up to 4 contexts to enable multi-function systems
- Spread-spectrum input clock support
- Multi-Camera synchronization support
- Multiple CFA options including RGB, mono and RCCC

Applications

- Automotive ADAS
- 1080p30 video applications
- High dynamic range imaging
- Mirror Replacement
- ADAS + Viewing Fusion

General Description

ON Semiconductor's AR0231AT is a 1/2.7-inch CMOS digital image sensor with a 1928Hx1208V active-pixel array. It captures images in either linear, high dynamic range, or LFM modes, with a rolling-shutter readout. The LFM mode eliminates high frequency LED flicker in the image allowing Traffic Sign Reading (TSR) algorithms to operate in all lighting conditions. It includes sophisticated camera functions such as in-pixel binning, windowing and both video and single frame modes. It is designed for both low light and high dynamic range scene performance. sensor fault detection features to enable camera ASIL B compliance. It is

programmable through a simple two-wire serial interface. The AR0231AT produces extraordinarily clear, sharp digital pictures, and its ability to capture both continuous video and single frames makes it the perfect choice for a wide range of applications, including automotive ADAS, automotive scene viewing, and 1080p HDR video.

Table 1: Key Parameters

| Parameter | Value | | | |
|----------------------------|---|--|--|--|
| Optical format | 1/2.7-inch (6.82 mm) | | | |
| Maximum resolution | 1928 x 1208 (2.3 Mp) | | | |
| Shutter type | Electronic Rolling Shutter (ERS) | | | |
| Pixel size | 3 μm x 3 μm | | | |
| Pixel output interfaces | Up to 4-lane HiSPi with SLVS and HiVCM options MIPI CSI-2 14-bit parallel | | | |
| Output formats | 16-bit Uncompressed Linear 20-bit Uncompressed HDR 14-bit, 10-bit, or 8 -bit Companded Linear 20-bit, 16-bit, 14-bit, or 12-bit Companded HDR | | | |
| Control interface | 2-wire, Serial Control 100 kHz/1 MHz | | | |
| Input clock range | 6-64 MHz in PLL mode 6-88 MHz Max in PLL-bypass Mode | | | |
| Maximum frame rate | Up to 40 fps at 1928 x 1208 / 3-exposure | | | |
| Output pixel clock maximum | 88 MHz | | | |
| Responsivity | TBD | | | |
| SNRmax | TBD | | | |
| Max Dynamic Range | >120 dB | | | |
| Packaging options | 11 x 10 iBGA Bare die | | | |
| Operating temp. range | –40°C to 105°C ambient | | | |
| Supply voltage | I/O 1.8 V or 2.8 V Digital 1.2 V Analog 2.8 V HiSPi 0.4 V or 1.8 V | | | |
| Power consumption | <680 mW typical (1928 x 1208, 30 fps) | | | |



AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Ordering Information

Ordering Information

Table 2: Available Part Numbers

| Part Number | Product Description | Orderable Product Attribute Description |
|--------------------------|---------------------|---|
| AR0231ATSC00XPEA0-DPBR-E | Odeg CRA, RGB iBGA | |
| AR0231ATSC00XPD20-E | Odeg CRA, RGB Die | |
| AR0231ATSG00XPEA0-DPBR-E | Odeg CRA, RGBC iBGA | |
| AR0231ATSG00XPD20-E | Odeg CRA, RGBC Die | |
| AR0231ATSR00XPEA0-DPBR-E | Odeg CRA, RCCC iBGA | |
| AR0231ATSR00XPD20-E | Odeg CRA, RCCC Die | |
| AR0231ATSC00XPEAH3-GEVB | RGB, Headboard | |
| AR0231ATSG00XPEAH3-GEVB | RGBC, Headboard | |
| AR0231ATSR00XPEAH3-GEVB | RCCC, Headboard | |
| AR0231ATSC00XPEAD3-GEVK | RGB, Demo Kit | |
| AR0231ATSG00XPEAD3-GEVK | RGBC, Demo Kit | |
| AR0231ATSR00XPEAD3-GEVK | RCCC, Demo Kit | |



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AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor General Description

General Description

The ON Semiconductor AR0231AT can be operated in its default mode or programmed for frame size, exposure, gain, and other parameters. The default mode output is a 1080p-resolution image at 40 frames per second (fps) in 3-exposure HDR mode and 30 fps in 4-exposure HDR mode through the HiSPi or MIPI ports. In linear mode, it outputs 12-bit, 10-bit, or 8-bit A-Law compressed raw data, using either the parallel or serial (HiSPi) output ports. In high dynamic range (HDR) mode, it outputs 12, 14-, or 16-bit compressed data using parallel output. In HiSPi or MIPI mode, 12-, 14-, 16-bit compressed, or 20-bit linearized data may be output. The device may be operated in video (master) mode or in single frame trigger mode. The LFM mode is used to minimize the impact of LED flicker for applications where there is dynamic LED lighting, such as TSR, and is output in linear mode.

FRAME_VALID and LINE_VALID signals are output on dedicated pins, along with a synchronized pixel clock in parallel mode.

The AR0231AT includes additional ASIL features: two on-board independent temperature sensor, startup tests, memory BIST, analog and digital CRC, and test patterns.

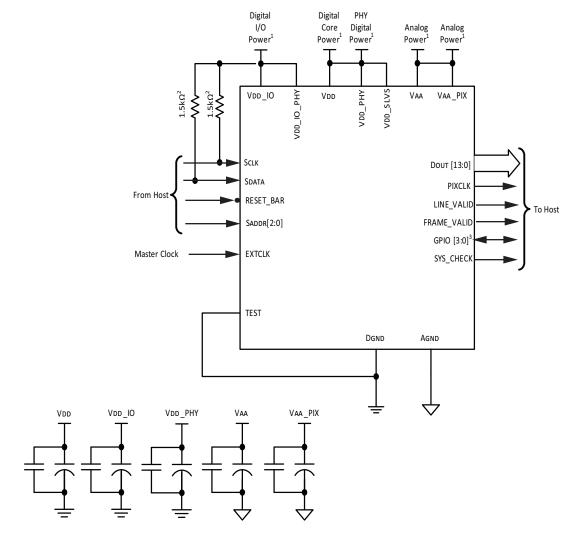
Optional register information and histogram statistic information can be embedded in the first and last 2 lines of the image frame.

Functional Overview

The AR0231AT is a 1/2.7 inch progressive-scan sensor that generates a stream of pixel data at a constant frame rate. It uses an on-chip, phase-locked loop (PLL) that can be optionally enabled to generate all internal clocks from a single master input clock running between 6 and 64 MHz. The PLL can also be bypassed in parallel mode, which allows for the input clock to run between 6 and 88 MHz. The maximum output pixel rate is 750 Mp/s, corresponding to a clock rate of 88 MHz. Figure 1 on page 7 to Figure 3 on page 9 show a configuration diagram of the sensor in parallel, HiSPi and MIPI interfaces.

AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Functional Overview

Figure 1: Typical Configuration, Parallel

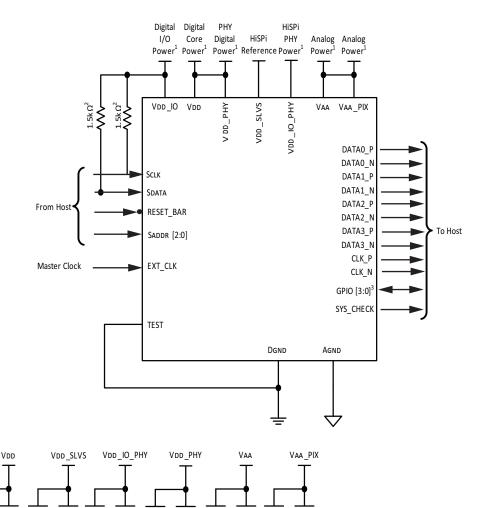


Notes:

- 1. All power supplies must be adequately decoupled.
- 2. ON Semiconductor recommends a resistor value of $1.5k\Omega$, but a greater value may be used for slower two-wire speed.
- 3. GPIO[2:0] can be left unconnected if not used. GPIO3 should be tied to DGND if not used.
- 4. The serial interface output pads can be left unconnected when the parallel output interface is used.
- 5. ON Semiconductor recommends that 0.1μF and 10μF decoupling capacitors for each power supply are mounted as close as possible to the pad. Actual values and results may vary depending on layout and design considerations. Refer to the AR0231AT demo headboard schematics for circuit recommendations.
- 6. ON Semiconductor recommends that analog power planes are placed in a manner such that coupling with the digital power planes is minimized.
- 7. I/O signals voltage must be configured to match VDD IO voltage to minimize any leakage currents.

AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Functional Overview

Figure 2: Typical Configuration, 4-Lane HiSPi



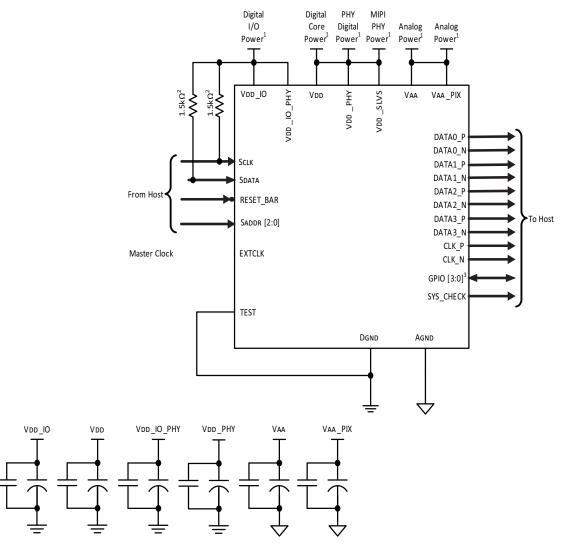
Notes:

Vpp IO

- 1. All power supplies must be adequately decoupled.
- 2. ON Semiconductor recommends a resistor value of 1.5 k Ω , but a greater value may be used for slower two-wire speed.
- 3. GPIO[2:0] can be left unconnected if not used. GPIO3 should be tied to DGND if not used.
- 4. The parallel interface output pads can be left unconnected when the serial output interface is used.
- 5. ON Semiconductor recommends that $0.1~\mu F$ and $10~\mu F$ decoupling capacitors for each power supply are mounted as close as possible to the pad. Actual values and results may vary depending on layout and design considerations. Refer to the AR0231AT demo headboard schematics for circuit recommendations.
- 6. ON Semiconductor recommends that analog power planes are placed in a manner such that coupling with the digital power planes is minimized.
- 7. I/O signals voltage must be configured to match VDD IO voltage to minimize any leakage currents.
- 8. If Vdd_IO is 1.8 V, then Vdd_IO_PHY cannot equal 2.8 V.

AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Functional Overview

Figure 3: Typical Configuration, 4-Lane MIPI



Notes:

- 1. All power supplies must be adequately decoupled.
- 2. ON Semiconductor recommends a resistor value of 1.5 k Ω , but a greater value may be used for slower two-wire speed.
- 3. The parallel interface output pads can be left unconnected if the serial output interface is used.
- 4. ON Semiconductor recommends that $0.1\,\mu\text{F}$ and $10\,\mu\text{F}$ decoupling capacitors for each power supply are mounted as close as possible to the pad. Actual values and results may vary depending on layout and design considerations. Refer to the AR0231 demo headboard schematics for circuit recommendations.
- 5. ON Semiconductor recommends that analog power planes are placed in a manner such that coupling with the digital power planes is minimized.
- 6. I/O signals voltage must be configured to match VDD_IO voltage to minimize any leakage currents.



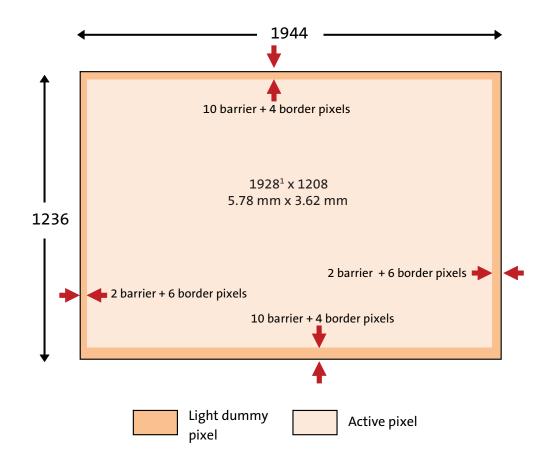
AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Pixel Data Format

Pixel Data Format

Pixel Array Structure

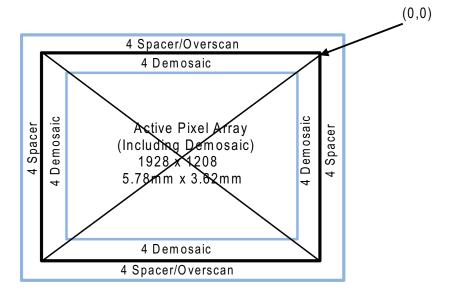
While the sensor's format is 1928x1208, additional active columns and active rows are included for use when horizontal or vertical mirrored readout is enabled, to allow readout to start on the same pixel. The pixel adjustment is always performed for monochrome or color versions. The active area is surrounded with optically transparent dummy pixels to improve image uniformity within the active area. Not all dummy pixels or barrier pixels can be read out.

Figure 4: Pixel Array Description



AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Pixel Data Format

Figure 5: Pixel Color Pattern Detail (Top Right Corner)

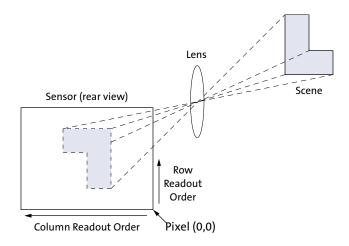


Default Readout Order

By convention, the sensor core pixel array is shown with pixel (0,0) in the top right corner (see Figure 5). This reflects the actual layout of the array on the die. Also, the first pixel data read out of the sensor in default condition is that of pixel (7, 7).

When the sensor is imaging, the active surface of the sensor faces the scene as shown in Figure 6. When the image is read out of the sensor, it is read one row at a time, with the rows and columns sequenced as shown in Figure 6.

Figure 6: Imaging a Scene





AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Operating Modes and Features

Operating Modes and Features

3.0 µm Dual Conversion Gain Pixel

To improve the low light performance and keep the high dynamic range, a large $(3.0\mu m)$ dual conversion gain pixel is implemented for better image optimization. With a dual conversion gain pixel, the conversion gain of the pixel may be dynamically changed to better adapt the pixel response based on dynamic range of the scene. This gain can be switched manually or automatically by an auto exposure control module.

Resolution

The active array supports a maximum of 1928 x 1208 pixels to support 1080p resolution. Utilizing a $3.0\mu m$ pixel will result in an optical format of 1/2.7-inch (approximately 6.82 mm diagonal).

Frame Rate

At full resolution, the AR0231AT is capable of running up to 30 fps in parallel mode and 40 fps in MIPI or HiSPi modes.

High Dynamic Range

The AR0231AT can operate in an HDR mode to acquire video data using ON Semiconductor's multi-exposure technology. This allows the sensor to handle >115 dB of intrascene dynamic range. The sensor also features a linear or standard dynamic range (SDR) mode where a single image is captured. In HDR mode, the sensor sequentially captures multiple exposures by maintaining separate read and reset pointers that are interleaved within the rolling shutter readout. The intermediate pixel values are stored in line buffers while waiting for all the exposure values to be present. As soon as all exposure values are available, they are combined to create a linearized 20-bit value for each pixel's response. This 20-bit value may be output directly or optionally compressed before output.

Individual control for T1, T2, T3, and T4 exposures is possible, allowing a wide range of exposure ratios within the maximum limits of each exposure line buffers allocated.

Individual T1, T2, T3 and T4 exposures can be output (depending on resolution/frame rate used) when in HDR mode for applications that require these to be processed individually.

Motion Compensation

In typical multi-exposure HDR systems, motion artifacts can be created when objects move during the integration time of the exposures used to construct the image. When this happens, edge artifacts can potentially be visible and might look like a tearing or ghosting effect. To correct for this issue, the AR0231AT incorporates the digital lateral overflow (DLO) algorithm as implemented in the AR0132, but with the addition of individual color knee points, as well as an additional knee point for the fourth exposure.

LED Flicker Mitigation (LFM)

LED sign flicker causes traffic signs to be incorrectly read in bright daylight conditions as the LEDs may be illuminated when the sensor is not integrating. The AR0231AT includes a new mode, LFM, for reading these signs. In LFM mode, pixels are floating-diffusion (FD) color merged in the vertical direction, and the effective sensitivity of the pixel pairs



AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Operating Modes and Features

can be controlled and reduced, enabling exposure times to be extended. On AR0231AT variants with color CFAs, color will be maintained in the sensor output to aid in sign discrimination. HDR output is not available during LFM operation. LFM mode is intended for machine vision applications and should not be used for viewing. A typical use case would be to capture 3 frames of HDR data, context switch to LFM for 1 frame, and then switch back HDR for video captured at 40fps. This allows for a 30 fps HDR video stream and a 10 fps LFM video stream.

In addition to LFM operation the AR0231AT will also support fractional gain down to 0.125x during normal operation.

Dual Conversion Gain (DCG)

To improve the low light performance and keep the high dynamic range, the AR0231AT has a dual conversion gain pixel implemented for better image optimization. With a dual conversion gain pixel, the conversion gain of the pixel may be dynamically changed to better adapt the pixel response based on dynamic range of the scene. This gain can be switched manually or automatically by an auto exposure control module.

Multi-camera Synchronization

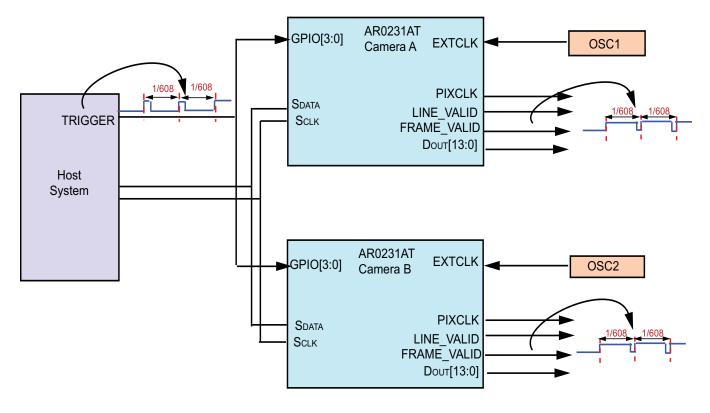
AR0231AT supports multi-camera synchronization Slave modes. The Slave modes support synchronization of multiple cameras within 8 pixel clocks from the beginning of FRAME_VALID/LINE_VALID from sensors without reducing the maximum frame rate. This feature saves the line memory buffer at the host system to combine a multiple of video input streams from the sensors.

Figure 7 on page 14 shows typical stereo camera systems using SLAVE mode.



AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Operating Modes and Features

Figure 7: Typical Stereo Camera Configuration



Slave Mode

The slave mode feature of the AR0231AT supports triggering the start of a frame readout from an input signal that is supplied from an external ASIC. The slave mode signal allows for precise control of frame rate and register change updates.

Context Switching and Register Updates

The user has the option of using the highly configurable context memory, or a simplified implementation in which only a subset of registers is available for switching. The AR0231AT supports a highly configurable context switching RAM of size 256×16 . Within this Context Memory, changes to any register may be stored. The register set for each context must be the same, but the number of contexts and registers per context are limited only by the size of the context memory.

Alternatively, the user may switch between two predefined register sets A and B by writing to a context switch change bit. When the context switch is configured to context A the sensor will reference the context A registers. If the context switch is changed from A to B during the readout of frame n, the sensor will then reference the context B coarse_integration_time registers in frame n+1 and all other context B registers at the beginning of reading frame n+2. The sensor will show the same behavior when changing from context B to context A. The following registers are context switchable:



AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Operating Modes and Features

Table 3: List of Configurable Registers for Context A and Context B

| Context A Register Description | Context B Register Description |
|-----------------------------------|-----------------------------------|
| coarse_integration_time | coarse_integration_time_cb |
| line_length_pck | line_length_pck_cb |
| frame_length_lines | frame_length_lines_cb |
| row_bin | row_bin_cb |
| col_bin | col_bin_cb |
| fine_gain | fine_gain_cb |
| coarse_gain | coarse_gain_cb |
| x_addr_start | x_addr_start_cb |
| y_addr_start | y_addr_start_cb |
| x_addr_end | x_addr_end_cb |
| y_addr_end | y_addr_end_cb |
| y_odd_inc | y_odd_inc_cb |
| x_odd_inc | x_odd_inc_cb |
| green1_gain | green1_gain_cb |
| blue_gain | blue_gain_cb |
| red_gain | red_gain_cb |
| green2_gain | green2_gain_cb |
| global_gain | global_gain_cb |
| operation_mode_ctrl | operation_mode_ctrl_cb |
| bypass_pix_comb | bypass_pix_comb_cb |

Embedded Data and Statistics

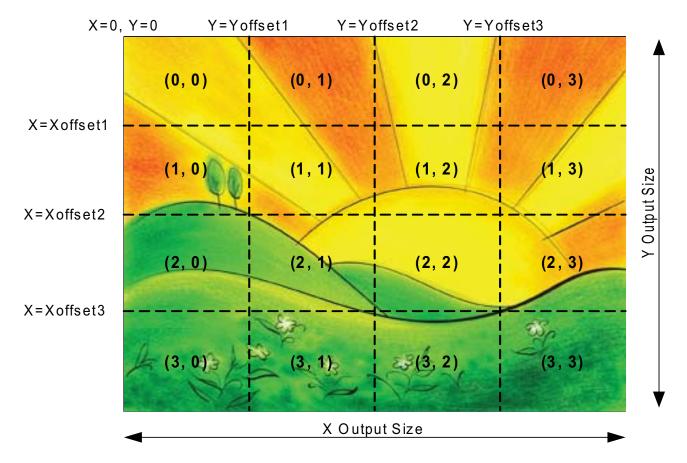
The AR0231AT can append embedded statistics to an output image frame, including frame identifiers and histogram information of that image. The sensor can provide histogram data for16regions of interest (ROIs) in addition to a histogram for the entire image, enabling downstream auto exposure algorithms to use these statistics in the most appropriate manner for the scene processing algorithms being used. Histogram for one of the pixel planes can be output at a time. The histograms are divided into 244 bins with a bin spacing of 64 evenly spaced bins for digital code values 0 to 212, 120 evenly spaced bins for values 212 to 216, 60 evenly spaced bins for values 216 to 220. The size and location of the ROIs are programmable via registers.

In addition to histograms, average pixel values for 16 ROI within the image can also be provided by the AR0231AT. Histogram information for one of the pixel planes can be output at a time. The virtual grid of regions is defined by four pointers in each of the X (X1 through X4) and Y (Y1 through Y4) directions, as shown in Figure 8. For each region the average pixel value is calculated, allowing a simple exposure metric for each region to be generated. Each of these averages can be included with the statistics embedded in the output image (as described above).

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AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Operating Modes and Features

Figure 8: Grid-ROI, Configuration 1; x_grid_status=0x3; y_grid_status=0x3



Black Level Control/Correction

Black level correction can optionally be automatically controlled by the AR0231AT; the default setting is for automatic black level calibration to be enabled. The automatic black level correction measures the average value of pixels from a set of optically black lines in the image sensor. The pixels are averaged as if they were light sensitive and passed through the appropriate gain. This line average is then digitally low-pass filtered over many frames to remove temporal noise and random instabilities associated with this measurement. The optically black lines may be read out, bypassing the datapath, for off-chip analysis. The automatic black level correction can be disabled and the black level set manually via register settings. Manual black level settings are frame synchronized to the next start of frame.

Row and Column Correction

Row and column noise correction is applied automatically by the image sensor on a frame by frame basis. Re-triggering of correction circuits due to settings or temperature changes are not necessary. No adjustments are provided for these correction circuits but they may be individually enabled/disabled.



AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Operating Modes and Features

Defective Pixel Tracking/Correction

Defective Pixel Correction (DPC) is intended to compensate for defective pixels by replacing their value with a value based on the surrounding pixels, making the defect less noticeable to the human eye. The defect pixel correction feature supports up to 200 defects. The locations of defective pixels are stored in a table on chip during the manufacturing process; this table is accessible through the two-wire serial interface. There is no provision for later augmenting the defect table entries. The DPC algorithm is one-dimensional, calculating the resulting averaged pixel value based on nearby pixels within a row. The algorithm distinguishes between color and monochrome parts; for color parts, the algorithm uses nearest neighbor in the same color plane. The defect pixel correction algorithm may be disabled. (Note that the outgoing defect specification for the AR0231AT assumes the defect correction is disabled). The defect pixels identified during manufacture can be read from on-chip ROM via the 2-wire control interface.

Analog/Digital Gains

A programmable analog gain of 0.125x to 8x applied simultaneously to all color channels will be featured along with a digital gain of 1x to 16x that may be configured on a per color channel basis.

Skipping/Binning Modes

The AR0231AT supports subsampling. Subsampling allows the sensor to read out a smaller set of active pixels by either skipping, binning, or summing pixels within the readout window. Horizontal binning is achieved in the digital readout. The sensor will sample the combined two adjacent pixels within the same color plane. Vertical row binning is applied in the pixel readout. Row binning can be configured as two rows within the same color plane. Pixel skipping can be configured up to two in both the x-direction and y-direction. Skipping pixels in the x-direction will not reduce the row time. Skipping pixels in the y direction will reduce the number of rows from the sensor effectively reducing the frame time. Skipping will introduce image artifacts from aliasing. The AR0231AT supports row wise vertical binning. Row wise vertical summing is not supported.

CFA Type Identification

CFA type (e.g. RGB, mono, etc.) may be determined by reading an identification register via the 2-wire control interface.



AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Operating Modes and Features

ASIL / ISO26262 Support Features

The AR0231AT incorporates many features to assist ASIL-B system compliance to be achieved by a system that integrates it. Table 4, "ASIL Support Features," on page 18 below shows a summary of these features.

Table 4: ASIL Support Features

| Feature | Description |
|--|---|
| Communication and Interface CRC | The sensor computes a CRC for data transmitted from the sensor to the host, permitting the host to identify transmission errors in such data. The sensor shall also expect a CRC value to be embedded in data transmitted from the host, and if the CRC fails, the sensor shall raise an error flag |
| Memory BIST | Writes a a pattern into all the bytes of all major SRAM blocks and read backs the values to detect stuck at 1 and stuck at 0 faults |
| CRC of Image Data | Image data transmission from the imager to the host will contain CRC (Cyclic Redundancy Checks) of data within a row to detect errors in communication (HiSpi). |
| Embedded Data | There are 2 rows of data which are prepended to the image frame output which are comprised of critical register contents. This allows imager register contents to be logged with each image. |
| Statistics Data | There are 2 rows of data which are appended to the image frame output which are comprised of critical image statistics information. |
| Digital Frame Counter | A 64-bit counter keeps track of the frame count and this value is included as part of embedded data. |
| Analog Frame Counter | There will be one row of data which will be prepended to the image frame output which consists of an analog representation of the Digital Frame Counter. |
| Column Address | There will be optional one row of data which will be prepended to the image frame output which consists of values which mirror the column address from which the data was read. This is an on-line test which ensures that the column decoder and vertical pixel routes are working properly prior to the output of each frame. |
| Row Address | There will be optional additional pixels of data prepended to each row of image data which consists of values which mirror the row address from which the data was read. This is an on-line test which ensures that the row decoder and horizontal pixel routes are working properly prior to the output of each frame. |
| On-line Analog and Digital Test Patterns | There will be a programmable number of rows (digital test pattern) prepended and/or appended to each frame of image data which enables on-line analog and/or digital fault monitoring. |
| Temperature Sensor | Two independent temperature sensors that report temperature in degrees Celsius from - 40 °C to 125°C. |



AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor System Interfaces

System Interfaces

This section describes the AR0231AT interfaces. Note that all output port options may not be available on all packaging options.

HiSPi Pixel Output Port

The AR0231AT provides a 4-lane HiSPi pixel output port with support for SLVS and HiVCM modes. Supported configurations are described in Table 5. Additional information is provided in the ON Semiconductor HiSPi Protocol and Physical Layer documents.

Table 5: HiSPi Protocol Support

| Lanes | Width | Data type | Protocols | Max. Mbps/lane | Notes |
|------------|--------|-----------|--|----------------|--------------------------------|
| 1, 2, or 4 | 20-bit | Bayer/RAW | SP-packetized SP-streaming Streaming-S | 750 Mbps | HDR output mode (uncompressed) |
| 1, 2, or 4 | 16-bit | Bayer/RAW | SP-packetized SP-streaming Streaming-S | 750 Mbps | HDR output mode (compressed) |
| 1, 2, or 4 | 14-bit | Bayer/RAW | SP-packetized SP-streaming Streaming-S | 750 Mbps | HDR output mode (compressed) |
| 1, 2, or 4 | 12-bit | Bayer/RAW | SP-packetized SP-streaming Streaming-S | 750 Mbps | SDR (linear) mode |

MIPI CSI-2 Pixel Output Port

The AR0231AT provides a 4-lane MIPI CSI-2 pixel output port. The data protocol support is per Table 6. Please contact ON Semiconductor for additional information.

Table 6: MIPI Protocol Support

| Lanes | Width | Data type | Protocols | Max. Mbps/lane | Notes |
|------------|--------|-----------|-------------------------------|----------------|--------------------------------|
| 1, 2, or 4 | 20-bit | Bayer/RAW | SP-packetized SP-streaming | 750 Mbps | HDR output mode (uncompressed) |
| 1, 2, or 4 | 16-bit | Bayer/RAW | SP-packetized SP-streaming | 750 Mbps | HDR output mode (compressed) |
| 1, 2, or 4 | 14-bit | Bayer/RAW | SP-packetized SP-streaming | 750 Mbps | HDR output mode (compressed) |
| 1, 2, or 4 | 12-bit | Bayer/RAW | SP-packetized SP-streaming | 750 Mbps | SDR (linear) mode |

Parallel Pixel Output Port

The AR0231AT provides a 14-bit data pixel output port with frame and line valid signals. HDR data companded to 12 bits or SDR (non-HDR) data may be output from this port.

Note that the parallel port cannot be used to output combinations of individual T1/T2/T3/T4 exposures on a per frame basis.



AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor System Interfaces

Line Interleaved Output

The AR0231AT will have the capability to output the T1, T2, T3, and T4 exposures separately, in a line interleaved format. The purpose of this is to enable off chip HDR linear combination and processing.

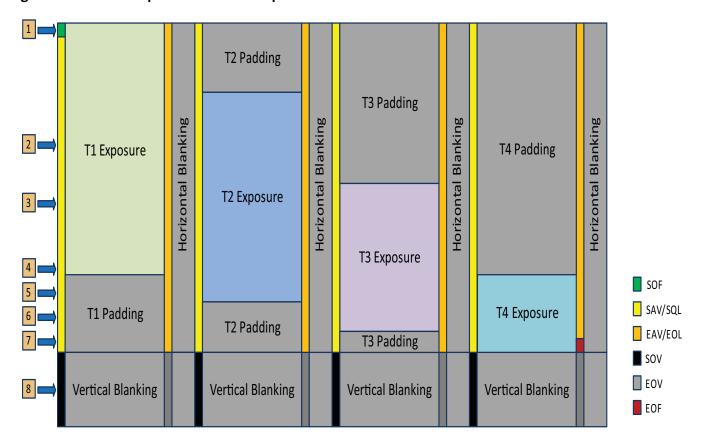
This section describes the line interleaved output format for HDR (multiple-exposure) readout.

General Notes:

- Terminology: "SOV" and "EOV" codes are the same as SAV/EAV with V bit = 1 (i.e. VBLANK)
- As with non-HDR readouts, end-of-line (EAV/EOL/EOV) sync codes are not required
- As with non-HDR readouts, explicit SOF and EOF codes are not required if blanking codes (SOV) are sent during VBLANK
- Sets of exposures cannot overlap. i.e. There must be "global VBLANK" period between the last exposure of Frame N and the first exposure of Frame N+1, during which no active data is read out

The AR0231AT will support a line-interleaved mode with active blanking. In this mode, each exposure line is delineated by its own SAV/SOL marker. Padding/Dummy lines for each exposure's individual VBLANK are sent as active lines delineated by their own SAV/SOL markers. See Figure 9 for an example of a three-exposure HDR frame.

Figure 9: Multi-Exposure Frame Example





AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor System Interfaces

Note: Each row readout happens from left to right (RO: T1>T2>T3>T4, T1>T2>T3>T4, ...)

Embedded data will be output only on the T1 data frame. Stats data will be output only on the T4 data frame. RNC is output only for T4 and on the T4 data frame.

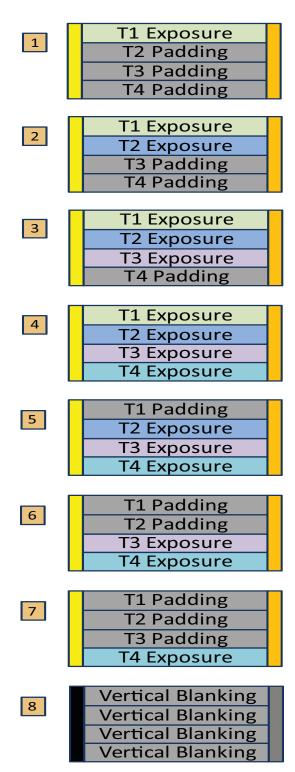
TAR is output only on the T4 data frame.

To more clearly illustrate how blanking data is embedded into the active readout, Figure 10 on page 22 shows the line-by-line readout at different points during the readout (Match the numbers with Figure 9 above). Note that actual vertical blanking occurs only when all exposures are completely read out. T1, T2, T3, or T4 Padding is inserted until all exposures have been read out. The Padding is treated as though it were a line of active video. The padding value is the same for T1, T2, T3, and T4 and is set to 0x0004.



AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor System Interfaces

Figure 10: Line by Line Readout





AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Electrical Specifications

Two-Wire Sensor Control Interface

The two-wire serial interface bus enables read/write access to control and status registers within the AR0231AT. The interface protocol uses a master/slave model in which a master controls one or more slave devices. The sensor acts as a slave device. The master generates a clock (SCLK) that is an input to the sensor and is used to synchronize transfers. Data is transferred between the master and the slave on a bidirectional signal (SDATA). SDATA is pulled up to VDD_IO off-chip by a $1.5 \mathrm{k}\Omega$ resistor. Either the slave or master device can drive SDATA LOW-the interface protocol determines which device is allowed to drive SDATA at any given time. The protocols described in the two-wire serial interface specification allow the slave device to drive SCLK LOW; the AR0231AT uses SCLK as an input only and therefore never drives it LOW.

Electrical Specifications

Table 7: Electrical Specifications

| Symbol | Definition | Min | Nominal | Max | Unit |
|------------|------------------------------|-----------|---------|---------|------|
| VDD | Core digital voltage | 1.14 | 1.2 | 1.26 | V |
| VDD_IO | I/O digital voltage | 1.7/2.52 | 1.8/2.8 | 1.9/3.0 | V |
| VAA | Analog voltage | 2.6 | 2.8 | 3.0 | V |
| VAA_PIX | Pixel supply voltage | 2.6 | 2.8 | 3.0 | V |
| VDD_PHY | PHY supply voltage | 1.14 | 1.2 | 2.16 | V |
| VDD_IO_PHY | Serial PHY supply voltage | 1.7 /2.52 | 1.8/2.8 | 1.9/3.0 | V |
| VDD_SLVS | HiSPi supply voltage (SLVS) | 0.3 | 0.4 | 0.6 | V |
| VDD_SLVS | HiSPi supply voltage (HiVCM) | 1.7 | 1.8 | 1.9 | V |

Note: VAA_PIX must always be equal to VAA.

Power Up

For controlled power up, RESET_BAR pin must be asserted (low) before supplies can be sequenced up in any order (except VPP). Once all supplies are valid, RESET_BAR is deasserted (high), the part will begin boot-up on EXTCLK.

Power Down

For controlled power down, streaming must be first disabled. The RESET_BAR pin must be asserted (low) before any external supplies are removed. Then the supplies are allowed to be sequenced off in any order.

Typical Power Down Sequence:

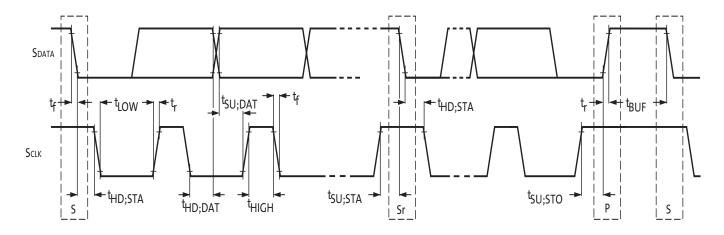
- 1. De-assert Streaming: Set software standby mode (mode_select = 0) register.
- 2. Wait till the end of the current frame (or end-of-line if so configured).
- 3. Configure I/O for "hold" if desired. "Hold" state requires maintaining VDD_IO; however.
- 4. Set RESET_BAR = 0. (Hard Standby, low-leakage state)
- 5. Wait t0 power-down delay.
- 6. Power off supplies in any order. For "hold" I/O state, do not power off VDD_IO supply.

AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Electrical Specifications

Two-Wire Serial Register Interface

The electrical characteristics of the two-wire serial register interface (SCLK, SDATA) are shown in Figure 11 and Table 8.

Figure 11: Two-Wire Serial Bus Timing Parameters



Note: Read sequence: For an 8-bit READ, read waveforms start after WRITE command and register address are issued.



AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor **Electrical Specifications**

Table 8: **Two-Wire Serial Bus Characteristics**

^fEXTCLK = 27 MHz; Vdd = 1.8V; Vdd_IO = 2.8V; VAA = 2.8V; VAA_PIX = 2.8V; Vdd_PLL = 2.8V; T_A = 25°C

| | | Standard Mode Fast Mode | | Mode | | |
|---|---------------------|-------------------------|-------------------|-------------------------|------------------|------|
| Parameter | Symbol | Min | Max | Min | Max | Unit |
| SCLK Clock Frequency | ^f SCL | 0 | 100 | 0 | 1000 | KHz |
| Hold time (repeated) START condition. After this period, the first clock pulse is generated | ^t HD;STA | 4.0 | - | 0.6 | - | μs |
| LOW period of the SCLK clock | ^t LOW | 4.7 | - | 1.3 | - | μs |
| HIGH period of the SCLK clock | ^t HIGH | 4.0 | - | 0.6 | = | μs |
| Set-up time for a repeated START condition | ^t SU;STA | 4.7 | - | 0.6 | - | μs |
| Data hold time | ^t HD;DAT | 04 | 3.45 ⁵ | 06 | 0.9 ⁵ | μs |
| Data set-up time | ^t SU;DAT | 250 | - | 100 ⁶ | - | ns |
| Rise time of both SDATA and SCLK signals | ^t r | - | 1000 | 20 + 0.1Cb ⁷ | 300 | ns |
| Fall time of both SDATA and SCLK signals | ^t f | - | 300 | 20 + 0.1Cb ⁷ | 300 | ns |
| Set-up time for STOP condition | ^t SU;STO | 4.0 | - | 0.6 | = | μs |
| Bus free time between a STOP and START condition | ^t BUF | 4.7 | - | 1.3 | - | μs |
| Capacitive load for each bus line | Cb | - | 400 | - | 400 | pF |
| Serial interface input pin capacitance | CIN_SI | - | 3.3 | - | 3.3 | pF |
| SDATA max load capacitance | CLOAD_SD | - | 30 | - | 30 | pF |
| SDATA pull-up resistor | RSD | 1.5 | 4.7 | 1.5 | 4.7 | ΚΩ |

- Notes: 1. This table is based on I²C standard (v2.1 January 2000). Philips Semiconductor.
 - 2. Two-wire control is I²C-compatible.
 - 3. All values referred to V_{IHmin} = 0.9 VDD and V_{ILmax} = 0.1 VDD levels. Sensor EXCLK = 27 MHz.
 - 4. A device must internally provide a hold time of at least 300 ns for the SDATA signal to bridge the undefined region of the falling edge of SCLK.
 - 5. The maximum ^tHD;DAT has only to be met if the device does not stretch the LOW period (^tLOW) of the SCLK signal.
 - 6. A Fast-mode I²C-bus device can be used in a Standard-mode I²C-bus system, but the requirement $^{\mathsf{t}}\mathsf{SU};\mathsf{DAT}^{\mathsf{T}}\mathsf{DAS}$ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLK signal. If such a device does stretch the LOW period of the SCLK signal, it must output the next data bit to the SDATA line tr max + tSU;DAT = 1000 + 250 = 1250 ns (according to the Standard-mode I²C-bus specification) before the SCLK line is released.
 - 7. Cb = total capacitance of one bus line in pF.

ON

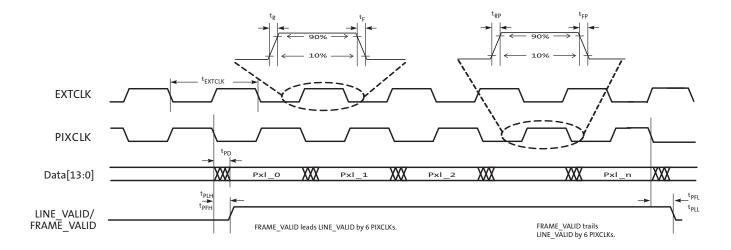
AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Electrical Specifications

I/O Timing

By default, the AR0231AT launches pixel data, FV, and LV with the falling edge of PIXCLK. The expectation is that the user captures $\mathtt{DOUT}[13:0]$, FV, and LV using the rising edge of PIXCLK.

See Figure 12 below and Table 9 on page 27 for I/O timing (AC) characteristics.

Figure 12: I/O Timing Diagram





AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Electrical Specifications

Table 9: I/O Timing Characteristics

| Symbol | Definition | Condition | Min | Тур | Max | Unit |
|-------------------------|------------------------------------|--------------------------------|------|------|-----|------|
| f _{EXTCLK1s} | Input clock frequency | | 6 | - | 64 | MHz |
| t _{EXTCLK1} | Input clock period | | 15.6 | _ | 166 | ns |
| t _R | Input clock rise time | | _ | 3 | _ | ns |
| t _F | Input clock fall time | | - | 3 | _ | ns |
| t _{RP} | Pixclk rise time | | - | 4 | _ | ns |
| t _{FP} | Pixclk fall time | | - | 4 | _ | ns |
| | Clock duty cycle | | 40 | 50 | 60 | % |
| t _{PIX JITTER} | Jitter on PIXCLK | | - | 1 | | ns |
| t _{CP} | EXTCLK to PIXCLK propagation delay | Nominal voltages, PLL Disabled | - | 32.4 | _ | ns |
| f _{PIXCLK} | PIXCLK frequency | Default, Nominal Voltages | 6 | | 88 | MHz |
| t _{PD} | PIXCLK to data valid | Default, Nominal Voltages | _ | 2.3 | _ | ns |
| t _{PFH} | PIXCLK to FV HIGH | Default, Nominal Voltages | - | 5.7 | _ | ns |
| t _{PLH} | PIXCLK to LV HIGH | Default, Nominal Voltages | - | 5.5 | _ | ns |
| t _{PFL} | PIXCLK to FV LOW | Default, Nominal Voltages | - | 4.3 | _ | ns |
| t _{PLL} | PIXCLK to LV LOW | Default, Nominal Voltages | - | 4.6 | - | ns |
| CLOAD | Output load capacitance | | - | <10 | - | pF |
| Cin | Input pin capacitance | | _ | 2.5 | _ | pF |

Note: I/O timing characteristics are measured under the following conditions:

- a. Temperature is 25°C ambient
- b. 10 pF load
- c. 1.8 V I/O supply voltage

Table 10: Parallel 12-bit 3-exposure HDR, Tint

All images taken in midlevel ambient lighting conditions, 2x gain, 1 ms integration time, 25C.

| Current Type | Condition | Symbol | Voltage | Min | Тур | Max |
|--|--------------------|--------------------|---------|-----|--------|-----|
| Analog Operating Current | Streaming Full Res | IAA | 2.8 | | 59.21 | |
| Digital Operating Current | Streaming Full Res | IDD | 1.2 | | 134.71 | |
| I/O Supply Current | Streaming Full Res | IDD_IO/ IDD_IO_PHY | 1.8 | | 11.02 | |
| PHY Supply Current | Streaming Full Res | IDD_PHY | 1.2 | | 3.51 | |
| Pixel Supply Current | Streaming Full Res | IAA_PIX | 2.8 | | 12.02 | |
| SLVS Supply Current Streaming Full Res | | IDD_SLVS | 1.2 | | -0.01 | |

Note: Operating currents measured under the following conditions:

- a. VAA and VAA_PIX are tied together
- b. $\ensuremath{\mathsf{VDD_IO}}$ PHY and $\ensuremath{\mathsf{VDD_IO}}$ are tied together
- c. PLL enabled and PIXLCK set to 88 MHz
- d. 3-exposure 12-bit Parallel mode at 33 fps
- e. Tj = 25°C



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Table 11: HiSPi HiVCM 16-bit 3-exposure HDR

| Current Type | Condition | Symbol | Voltage | Min | Тур | Max |
|---------------------------|--------------------|---------------------|---------|-----|--------|-----|
| Analog Operating Current | Streaming Full Res | IAA | 2.8 | | 65.87 | |
| Digital Operating Current | Streaming Full Res | IDD | 1.2 | | 148.35 | |
| I/O Supply Current | Streaming Full Res | IDD_IO / IDD_IO_PHY | 1.8 | | 38.03 | |
| PHY Supply Current | Streaming Full Res | IDD_PHY | 1.8 | | 13.05 | |
| Pixel Supply Current | Streaming Full Res | IAA_PIX | 2.8 | | 13.75 | |
| SLVS Supply Current | Streaming Full Res | IDD_SLVS | 1.2 | | 0.2 | |

Note: Operating currents measured under the following conditions

- a. VAA and VAA_PIX are tied together
- b. VDD_IO_PHY and VDD_IO are tied together
- c. PLL enabled and PIXLCK set to 88 MHz
- d. 4-lane 3-exposure 16-bit HiSPi HiVCM mode at 40 fps
- e. Tj = 25°C

Table 12: HiSPi SLVS 16-bit 3-exposure HDR, 40 FPS, 1 ms tint, 2x gain

| Current Type | Condition | Symbol | Voltage | Min | Тур | Max |
|---------------------------|--------------------|---------------------|---------|-----|--------|-----|
| Analog Operating Current | Streaming Full Res | IAA | 2.8 | | 65.87 | |
| Digital Operating Current | Streaming Full Res | IDD | 1.2 | | 148.43 | |
| I/O Supply Current | Streaming Full Res | IDD_IO / IDD_IO_PHY | 1.8 | | 31.52 | |
| PHY Supply Current | Streaming Full Res | IDD_PHY | 1.2 | | 13.07 | |
| Pixel Supply Current | Streaming Full Res | IAA_PIX | 2.8 | | 13.75 | |
| SLVS Supply Current | Streaming Full Res | IDD_SLVS | 1.2 | | -0.01 | |

Note: Operating currents measured under the following conditions

- a. VAA and VAA_PIX are tied together
- b. ${\tt VDD_IO_PHY}$ and ${\tt VDD_IO}$ are tied together
- c. PLL enabled and PIXLCK set to 88 MHz
- d. 4-lane 3-exposure 16-bit HiSPi SLVS mode at 40 fps
- e. Tj = 25°C

Table 13: MIPI 16-bit 3-exposure HDR,

| Current Type | Condition | Symbol | Voltage | Min | Тур | Max |
|------------------------------|--------------------|---------------------|---------|-----|--------|-----|
| Analog Operating Current | Streaming Full Res | IAA | 2.8 | | 65.89 | |
| Digital Operating Current | Streaming Full Res | IDD | 1.2 | | 149.35 | |
| I/O Supply Current | Streaming Full Res | IDD_IO / IDD_IO_PHY | 1.8 | | 0.07 | |
| PHY Supply Current | Streaming Full Res | IDD_PHY | 1.8 | | 10.37 | |
| Pixel Supply Current | Streaming Full Res | IAA_PIX | 2.8 | | 13.76 | |
| SLVS Supply Current | Streaming Full Res | IDD_SLVS | 1.2 | | 8.29 | |

Note: Operating currents measured under the following conditions

- a. VAA and VAA_PIX are tied together
- b. VDD IO PHY and VDD IO are tied together
- c. PLL enabled and PIXLCK set to 88 MHz
- d. 4-lane 3-exposure 16-bit MIPI mode at 40 fps
- e. Tj = 25°C



AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Electrical Specifications

HiSPi Electrical Specifications

The ON Semiconductor AR0231AT sensor supports both SLVS and HiVCM HiSPi modes. Please refer to the High-Speed Serial Pixel (HiSPi) Interface Physical Layer Specification v2.00.00 for electrical definitions, specifications, and timing information. The VDD_SLVS supply in this datasheet corresponds to VDD_TX in the HiSPi Physical Layer Specification. Similarly, VDD is equivalent to VDD_HiSPi as referenced in the specification. The DLL as implemented on AR0231AT is limited in the number of available delay steps and differs from the HiSPi specification as described in this section.

Table 14: Channel Skew

Measurement Conditions: VDD_HiSPi = 1.8V;VDD_HiSPi_TX = 0.4V; Data Rate =480 Mbps; DLL set to 0

| Data Lane Skew in Reference to Clock | tCHSKEW1PHY | -150 | ps |
|--------------------------------------|-------------|------|----|

AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Power-On Reset and Standby Timing

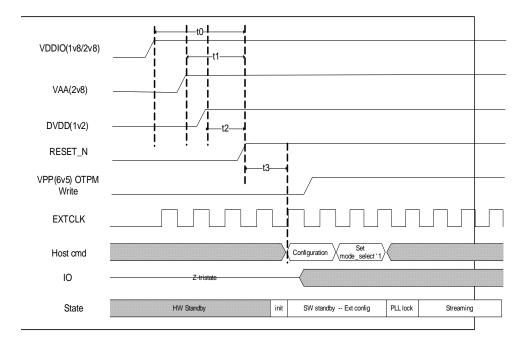
Power-On Reset and Standby Timing

Power-Up Sequence

A typical power-up sequence:

- 1. Set RESET_BAR low
- 2. Power up supplies (except VPP should be kept low).
- 3. Wait for current to be applied on t0, t1, t2, controlled by external supply slew rate (See Figure 13).
- 4. When external supplies valid, set RESET_BAR high.
- 5. HOST config through IIC.
- 6. Set STREAMING bit.
- 7. PLL internally enables and locks.
- 8. AR0231 enters streaming mode.

Figure 13: Initial Power-Up Sequence





AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Power-On Reset and Standby Timing

Table 15: AR0231 Pin List

| PIN Name | iBGA Pin | Туре | Descriptions | Comments | |
|---------------|----------|--------------|---|--|--|
| EXTCLK | B4 | Input | Master input clock. PLL input clock. | Connect to clock source. Min and Max frequency depends upon output port and clocking method. | |
| RESET_BAR | C5 | Input | Asynchronous active-low reset. | Connect to host. | |
| Sclk | H8 | Input | CCI clock for access to control and status registers. | Connect to host. | |
| Sdata | H9 | Input/Output | CCI data for reads from and writes to control and status registers. | Connect to host. | |
| Saddr0 | К9 | Input | CCI interface device address select bit 0. | Selects CCI address. Please see Table | |
| SADDR1 | K8 | Input | CCI interface device address select bit 1. | XXXX for connection info. Connect | |
| SADDR2 | K7 | Input | CCI interface device address select bit 2. | to VDD_IO or DGND accordingly. | |
| PIXCLK | F2 | Output | Parallel data output pixel clock.Used to qualify the LINE_VALID, FRAME_VALID and DOUT13 to DOUT0 outputs. | | |
| FRAME_VALID | G3 | Output | Parallel data output FRAME_VALID output. Qualified by PIXCLK. | | |
| LINE_VALID | G4 | Output | Parallel data output LINE_VALID output. Qualified by PIXCLK. | | |
| Dout13 | J2 | Output | Parallel data output pixel data bit 13. Qualified by PIXCLK. | | |
| Dout12 | J3 | Output | Parallel data output pixel data bit 12. Qualified by PIXCLK. | | |
| Dout11 | H2 | Output | Parallel data output pixel data bit 11. Qualified by PIXCLK. | | |
| Dout10 | Н3 | Output | Parallel data output pixel data bit 10. Qualified by PIXCLK. | | |
| Dоит9 | G2 | Output | Parallel data output pixel data bit 9. Qualified by PIXCLK. | Connect to host/receiver or can be | |
| Dоит8 | F3 | Output | Parallel data output pixel data bit 8. Qualified by PIXCLK. | left floating if not used. Use DOUT[11:0] for 12-bit parallel configuration. | |
| Dоит 7 | E3 | Output | Parallel data output pixel data bit 7. Qualified by PIXCLK. | configuration. | |
| D оит6 | E2 | Output | Parallel data output pixel data bit 6. Qualified by PIXCLK. | | |
| D оит5 | D3 | Output | Parallel data output pixel data bit 5. Qualified by PIXCLK. | | |
| Dоит4 | D2 | Output | Parallel data output pixel data bit 4. Qualified by PIXCLK. | | |
| D оит3 | C3 | Output | Parallel data output pixel data bit 3. Qualified by PIXCLK. | 1 | |
| Dоит2 | C4 | Output | Parallel data output pixel data bit 2. Qualified by PIXCLK. | | |
| Dоит1 | В3 | Output | Parallel data output pixel data bit 1. Qualified by PIXCLK. | | |
| Dоит0 | B2 | Output | Parallel data output pixel data bit 0. Qualified by PIXCLK. | | |



AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Power-On Reset and Standby Timing

Table 15: AR0231 Pin List (continued)

| PIN Name | iBGA Pin | Туре | Descriptions | Comments |
|-----------|--|--------------|---|---|
| CLK_P | A8 | Output | Differential Mipi/HiSpi serial clock. | |
| CLK_N | B8 | Output | Differential Mipi/HiSpi serial clock. | |
| DATA3_P | B10 | Output | Differential Mipi/HiSpi serial data lane 3. | |
| DATA3_N | A10 | Output | Differential Mipi/HiSpi serial data lane 3. | Connect to host/receiver or can be |
| DATA2_P | A9 | Output | Differential Mipi/HiSpi serial data lane 2. | left floating if not used. Use DATA0 |
| DATA2_N | B9 | Output | Differential Mipi/HiSpi serial data lane 2. | for 1 lane configuration or DATA0 |
| DATA1_P | В7 | Output | Differential Mipi/HiSpi serial data lane 1. | and DATA1 for 2 lane configuration. |
| DATA1_N | A7 | Output | Differential Mipi/HiSpi serial data lane 1. | |
| DATA0_P | A6 | Output | Differential Mipi/HiSpi serial data lane 0. | |
| DATA0_N | В6 | Output | Differential Mipi/HiSpi serial data lane 0. | |
| TEST | K2 | Input | Enable manufacturing test modes. | Tie to DGND. |
| ATEST1 | G8 | Input/Output | _ | |
| ATEST2 | G9 | Input/Output | Analog manufacturing test access | |
| ATEST3 | G10 | Input/Output | Analog manufacturing test access | Leave unconnected. |
| ATEST4 | G11 | Input/Output | Analog manufacturing test access | |
| GPIO0 | J9 | Input/Output | GPIO Pin 0 | |
| GPIO1 | J8 | Input/Output | | GPIO[2:0] can be left unconnected if |
| GPIO2 | K11 | Input/Output | | not used. GPIO3 should be tied to DGND if not used. |
| GPIO3 | K10 | Input/Output | GPIO Pin 3 | DGND II flot used. |
| SYS_CHECK | J10 | Output | 5th GPIO pin is dedicated | Leave unconnected if not used. |
| TEMP FLAG | H10 | Output | Temperature monitoring flag | Leave unconnected. |
| DGND | E1, G1, J1, A2, K3, L3, D4, E4, F4, H4, J4, K4, B5, D5, E5, F5, G5, H5, J5, K5, D6, E6, F6, G6, H6, J6, K6, L6, D7, E7, F7, G7, H7, J7, C8, D8, E8, F8, L9, C10 | Power | Digital ground. | |
| VDD NUV | B1, F1, K1, L2, A3, A4, L5, L8, L10, B11, J11 | Power | Core Digital power. | Connect to Von |
| VDD_PHY | C7 | Power | PHY Digital power. | Connect to VDD |
| VDD_IO | A1, D1, H1, L1, L4, A5, L7, A11, H11, L11 | Power | Digital I/O power. | |
| AGND | C2, D9, E9, F9, F11 | Power | Analog ground. | |



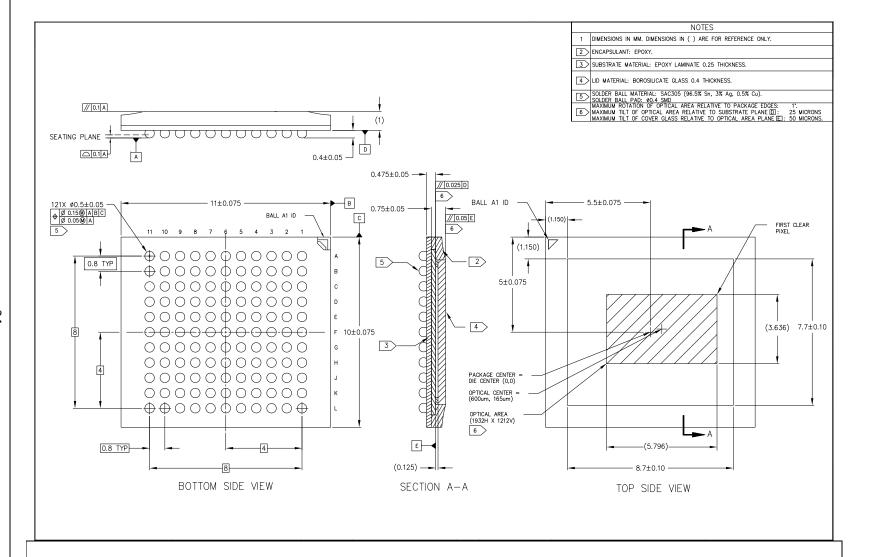
AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Power-On Reset and Standby Timing

Table 15: AR0231 Pin List (continued)

| PIN Name | iBGA Pin | Туре | Descriptions | Comments |
|------------|------------------------------|-------|---|--|
| VAA | C1, D10, E10, F10, E11 | Power | Analog power. | |
| VAA_PIX | D11 | Power | Analog pixel array power. | Connect to VAA |
| VDD_IO_PHY | C9 | Power | Power to MIPI and HiSPi PHYs. | Use 1.8V nominal for HiSPi HiVCM or Sub-LVDS. Use 1.8V or 2.8V nominal for MIPI or HiSPi SLVS. Tie to VDD_IO when Parallel interface is used. |
| VDD_SLVS | C6 | Power | Reference voltage for HiSPi serial interface. | Set according to desired HiSPi output common mode voltage. Use 0.4V nominal for HiSPi SLVS, otherwise use 1.2V nominal. Tie to VDD when MIPI is being used |
| VPP | C11 | Power | High voltage supply for programming OTPM. | Leave unconnected. |

AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Package Drawing

Package Drawing





AR0231AT: 1/2.7-Inch 2.3 Mp Digital Image Sensor Revision History

Revision History

- Converted to ON Semiconductor template
- Changed title
- Updated "Features," on page 1
- Added "Applications," on page 1
- Added "General Description," on page 1
- Updated Table 1, "Key Parameters," on page 1
- Updated Table 2, "Available Part Numbers," on page 2
- Updated "General Description," on page 6
- Updated "Functional Overview," on page 6
- Replaced "Figure 1: Typical Configuration" with "Figure 1: "Typical Configuration, Parallel," on page 7 and Figure 2: "Typical Configuration, 4-Lane HiSPi," on page 8
- Added "Pixel Data Format," on page 10
- Updated "Default Readout Order" on page 11
- Updated "LED Flicker Mitigation (LFM)" on page 12
- Updated "High Dynamic Range" on page 12
- Added "Dual Conversion Gain (DCG)" on page 13
- Updated "Multi-camera Synchronization" on page 13
- Updated Figure 7: "Typical Stereo Camera Configuration," on page 14
- Added "Slave Mode" on page 14
- Updated "Context Switching and Register Updates" on page 14
- Updated "Embedded Data and Statistics" on page 15
- Added "Analog/Digital Gains" on page 17
- Added "Skipping/Binning Modes" on page 17
- Updated Table 4, "ASIL Support Features," on page 18
- Updated Table 5, "HiSPi Protocol Support," on page 19
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| | Added Table 15, "AR0231 Pin List," on page 31 Added "Package Drawing" on page 34 |
|--------|---|
| Rev. 1 | |
| | • Initial release |

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